

Please insert between lines 14 and 15:

7d mount

Please correct line 20 as follows:

10 microcomponent

IN THE CLAIMS:

This amendment is based upon the claims as amended in the enclosed Preliminary Examination Report.

Please substitute the following claims for the pending claim of the same number.

- A)
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1. (Amended) A procedure for the replicative fabrication and packaging of at least one microstructured molded part in form of one magazine/molded part composite, comprising the following process steps:
- a. Replicatively fabricating at least one microstructured molded part using an initially closed tool which comprises at least one first and one second tool half;
 - b. Opening both tool halves, whereby the molded part remains in the first tool half;
 - c. Replacing at least the second tool half with at least one additional tool half;
 - d. Replicatively fabricating the magazine using the first tool half which contains the molded part and the additional tool half;
 - e. Simultaneously demolding the magazine and the molded part as one magazine/molded part composite.

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2. (Amended) A procedure for the replicative fabrication and packaging of at least one microstructured molded part as one magazine/molded part composite, comprising the following process steps:
- a. Replicatively fabricating the magazine using an initially closed tool which comprises at least one first and one second tool half;
 - b. Opening both tool halves, whereby the magazine remains in the first tool half;
 - c. Replacing at least the second tool half with at least one additional tool half;
 - d. Replicatively fabricating at least one microstructured molded part using the first tool half which contains the magazine and the additional tool half;
 - e. Simultaneously demolding the magazine and the molded part as one magazine/molded part composite.
3. (Amended) A procedure according to Claim 1, wherein at least one microstructured mold insert is used for fabrication of the magazine and/or the molded part in the tool.
4. (Amended) A procedure according to Claim 1, wherein the molded part and the magazine is fabricated with different physical heights.
5. (Amended) A procedure according to Claim 1, wherein the magazine is fabricated with a lateral overhang in comparison to the horizontal dimension of the molded part.
6. (Amended) A procedure according to Claim 1, wherein the magazine is fabricated with a holding contact to parts of the side surfaces of the molded part.

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7. (Amended) A procedure according to Claim 1, wherein the magazine is fabricated with a holding contact to the microstructures of the molded parts.
 8. (Amended) A procedure according to Claim 1, wherein the magazine is fabricated with recesses.
 9. (Amended) A procedure according to Claim 1, wherein the magazine is fabricated with a holding contact to the bottom or face surface of the molded part.
 10. (Amended) A procedure according to Claim 1, wherein the magazine is fabricated with a holding contact to parts of the bottom or parts of the face surface of the molded part.
 11. (Amended) A procedure according to Claim 1, wherein the molded part and the magazine are fabricated with the same or with different mold materials.
 12. (Amended) A procedure for the replicative fabrication and packaging of at least one microstructured molded part as one magazine/molded part composite,
comprising the following process steps:
 - a. Replicatively fabricating at least one microstructured molded part using a prefabricated magazine;
 - b. Simultaneously demolding the magazine and the molded parts as one magazine/molded part composite.
 13. (Amended) A procedure according to Claim 12, wherein a split tool is used which comprises at least one first and one second tool half.

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14. (Amended) A procedure according to Claim 12, wherein a prefabricated magazine is used after removal of the microstructured molded parts.
15. (Amended) A magazine with at least one microstructured molded part, comprising: a prefabricated magazine/molded part composite, wherein the magazine is connected to the molded part through a holding contact while leaving some open/free spaces at its side surfaces.
16. (Amended) A magazine according to Claim 15, wherein the magazine has a different physical height in comparison to the molded part.
17. (Amended) A magazine according to Claim 15, wherein the magazine has a wafer form in a standard format common for semiconductor technology.
18. (Amended) A magazine according to Claim 15, wherein the magazine is connected to the molded part at its microstructures.
19. (Amended) A magazine according to Claim 15, wherein the magazine adjoins the side surfaces of the molded part has at least one recess.
20. (Amended) A magazine according to Claim 15, wherein the magazine is connected across the entire bottom or face surface of the molded part.